

SANYO Semiconductors DATA SHEET

2SJ655 — General-Purpose Switching Device Applications

Features

- · Low ON-resistance.
- 4V drive.
- · Ultrahigh-speed switching.
- · Motor drive, DC / DC converter.
- · Avalanche resistance guarantee.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		-100	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		-12	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	-48	Α
Allowable Power Dissipation	D-		2.0	W
	PD	Tc=25°C	25	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		144	mJ
Avalanche Current *2	IAV		-12	Α

Note: *1 VDD=-50V, L=1mH, IAV=-12A

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Drain-to-Source Breakdown Voltage	V(BR)DSS	I _D =-1mA, V _G S=0V	-100			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =-100V, V _{GS} =0V			-1	μΑ
Gate-to-Source Leakage Current	IGSS	$V_{GS}=\pm 16V$, $V_{DS}=0V$			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =-10V, I _D =-1mA	-1.2		-2.6	V
Forward Transfer Admittance	yfs	V _{DS} =-10V, I _D =-6A	9	13		S
Static Drain-to-Source On-State Resistance	RDS(on)1	I _D =-6A, V _G S=-10V		100	136	mΩ
	RDS(on)2	I _D =-6A, V _G S=-4V		136	190	mΩ

Marking: J655 Continued on next page.

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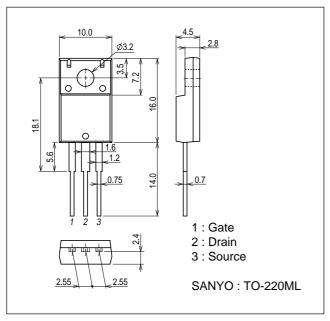
^{*2} L≤1mH, Single pulse

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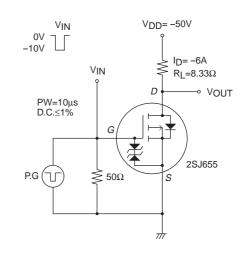
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Oill
Input Capacitance	Ciss	V _{DS} =-20V, f=1MHz		2090		pF
Output Capacitance	Coss	V _{DS} =-20V, f=1MHz		155		pF
Reverse Transfer Capacitance	Crss	V _{DS} =-20V, f=1MHz		108		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		17		ns
Rise Time	t _r	See specified Test Circuit.		95		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		187		ns
Fall Time	tf	See specified Test Circuit.		95		ns
Total Gate Charge	Qg	V _{DS} =-50V, V _{GS} =-10V, I _D =-12A		41		nC
Gate-to-Source Charge	Qgs	V _{DS} =-50V, V _{GS} =-10V, I _D =-12A		7		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =-50V, V _{GS} =-10V, I _D =-12A		9		nC
Diode Forward Voltage	V _{SD}	I _S =-12A, V _{GS} =0V		-0.88	-1.2	V

Package Dimensions

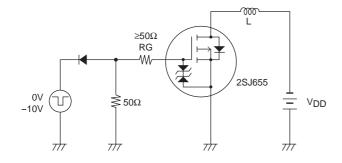
unit : mm (typ) 7508-003

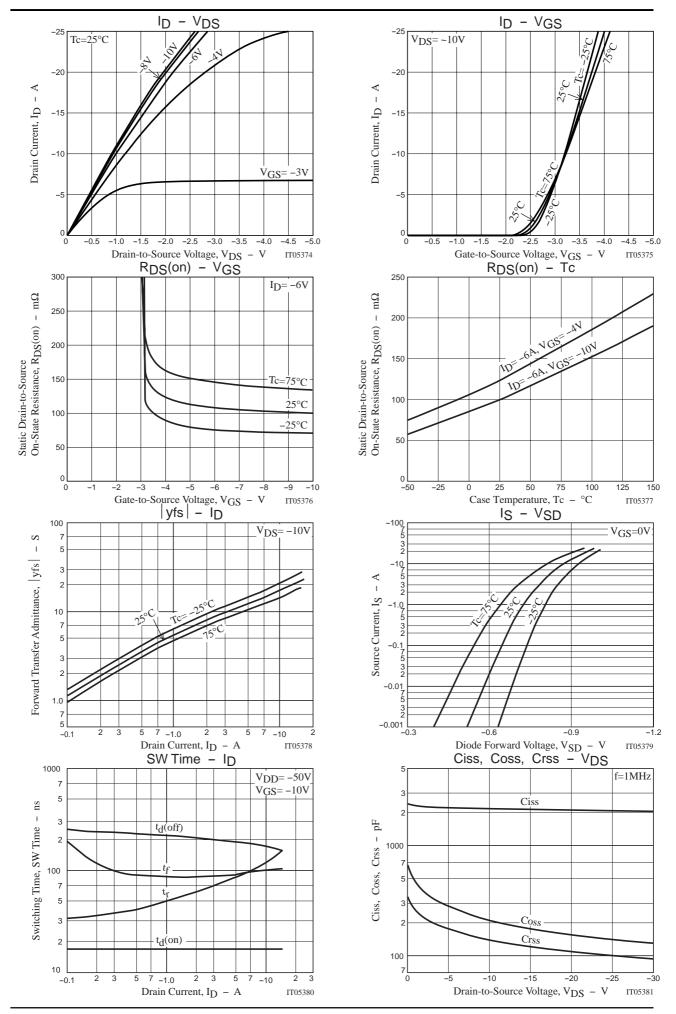


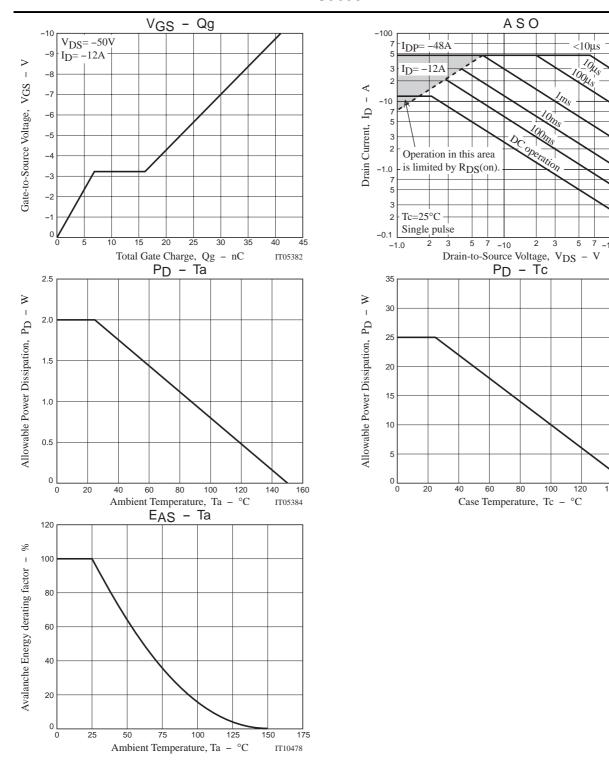
Switching Time Test Circuit



Avalanche Resistance Test Circuit







160 IT05385

Note on usage: Since the 2SJ655 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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